Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

Product information in this catalog is as of October 2012. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that Taiyo Yuden Co., Ltd. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact Taiyo Yuden Co., Ltd. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact Taiyo Yuden Co., Ltd. for more detail in advance. Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").

 It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.
- Please note that Taiyo Yuden Co., Ltd. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. Taiyo Yuden Co., Ltd. grants no license for such rights.
- Caution for export

 Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

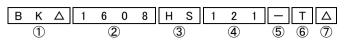
MULTILAYER CHIP BEAD INDUCTORS(BK SERIES)





*Except for BK0402, BK0603, BK1005, BKH1005

■PARTS NUMBER



1	_						
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Code	Series name					
ВК△	Multilayer chip bead inductor					
ВКН						

②Dimensions (L×W)

Code	Type (inch)	Dimensions (L×W)[mm]
0402	0402 (01005)	0.4 × 0.2
0603	0603(0201)	0.6 × 0.3
1005	1005 (0402)	1.0 × 0.5
1608	1608 (0603)	1.6 × 0.8
2125	2125 (0805)	2.0 × 1.25

3Material

Olviaconai	
Code	Material
HW	
HS	
HR	
НМ	Refer to impedance curves
LM	for material differences
LL	
TS	
TM	
·	<u>-</u>

4 Nominal impedance

△=Blank space

Code (example)	Nominal impedance[Ω]
150	15
101	100
102	1000

⑤Characteristics

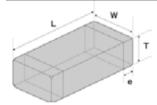
Code	Characteristics
-	Standard

6Packaging

9	
Code	Packaging
т	Tanina

Uniternal code	
Code	Internal code
Δ	Standard

■ STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Tuna		W T			Standard quantity [pcs]		
Туре	L	VV	ı	е	Paper tape	Embossed tape	
BK 0402 (01005)	0.40±0.02 (0.016±0.001)	0.20±0.02 (0.008±0.001)	0.20±0.02 (0.008±0.001)	0.10+0.04/-0.03 (0.004+0.002/-0.001)	20000	_	
BK 0603 (0201)	0.60±0.03 (0.2±0.001)	0.30±0.03 (0.012±0.001)	0.30±0.03 (0.012±0.001)	0.15±0.05 (0.006±0.002)	15000	_	
BK 1005 BKH1005 (0402)	1.00±0.05 (0.039±0.002)	0.50±0.05 (0.020±0.002)	0.50±0.05 (0.020±0.002)	0.25±0.10 (0.010±0.004)	10000	_	
BK 1608 (0603)	1.6±0.15 (0.063±0.006)	0.8±0.15 (0.031±0.006)	0.8±0.15 (0.031±0.006)	0.3±0.2 (0.012±0.008)	4000	_	
BK 2125	2.0+0.3/-0.1 (0.079+0.012/-0.004)	1.25±0.2 (0.049±0.008)	0.85±0.2 (0.033±0.008)	0.5±0.3 (0.020±0.012)	4000	_	
(0805)	2.0+0.3/-0.1 (0.079+0.012/-0.004)	1.25±0.2 (0.049±0.008)	1.25±0.2 (0.049±0.008)	0.5±0.3 (0.020±0.012)	_	2000	

Unit:mm(inch)

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BK 0402

Parts number	EHS	Nominal impedance [Ω]	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω] (max.)	Rated current [mA] (max.)	Thickness [mm]
BK 0402HS100-T	R ₀ HS	10	±5	100	0.10	540	0.20 ±0.02
BK 0402HS700-T	R ₀ HS	70	±25%	100	0.37	280	0.20 ±0.02
BK 0402HS121-T	RoHS	120	±25%	100	0.53	240	0.20 ±0.02
BK 0402HM750-T	RoHS	75	±25%	100	0.45	260	0.20 ±0.02
BK 0402HM121-T	R₀HS	120	±25%	100	0.60	220	0.20 ±0.02
BK 0402LL220-T	R₀HS	22	±25%	100	0.70	150	0.20 ±0.02

BK 0603

Parts number	EHS	Nominal impedance [Ω]	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω] (max.)	Rated current [mA] (max.)	Thickness [mm]
BK 0603HS220-T	RoHS	22	±25%	100	0.065	500	0.30 ±0.03
BK 0603HS330-T	RoHS	33	±25%	100	0.070	500	0.30 ±0.03
BK 0603HS800-T	RoHS	80	±25%	100	0.40	200	0.30 ±0.03
BK 0603HS121-T	RoHS	120	±25%	100	0.45	200	0.30 ±0.03
BK 0603HS241-T	RoHS	240	±25%	100	0.65	200	0.30 ±0.03
BK 0603HS601-T	RoHS	600	±25%	100	1.20	150	0.30 ±0.03
BK 0603HM600-T	RoHS	60	±25%	100	0.25	200	0.30 ±0.03
BK 0603HM121-T	RoHS	120	±25%	100	0.40	200	0.30 ±0.03
BK 0603HM241-T	RoHS	240	±25%	100	0.80	200	0.30 ±0.03
BK 0603HM471-T	RoHS	470	±25%	100	1.05	100	0.30 ±0.03
BK 0603HM601-T	RoHS	600	±25%	100	1.20	100	0.30 ±0.03
BK 0603LL100-T	RoHS	10	±25%	100	0.25	200	0.30 ±0.03
BK 0603LL220-T	RoHS	22	±25%	100	0.45	200	0.30 ±0.03
BK 0603LL330-T	RoHS	33	±25%	100	0.55	150	0.30 ± 0.03
BK 0603LL470-T	RoHS	47	±25%	100	0.70	150	0.30 ± 0.03
BK 0603LL560-T	RoHS	56	±25%	100	1.00	100	0.30 ± 0.03
BK 0603LL800-T	RoHS	80	±25%	100	1.30	100	0.30 ± 0.03
BK 0603LL121-T	RoHS	120	±25%	100	1.50	100	0.30 ±0.03
BK 0603TS800-T	RoHS	80	±25%	100	0.18	500	0.30 ±0.03
BK 0603TS121-T	RoHS	120	±25%	100	0.23	450	0.30 ±0.03
BK 0603TS241-T	RoHS	240	±25%	100	0.32	400	0.30 ±0.03
BK 0603TS601-T	RoHS	600	±25%	100	0.75	270	0.30 ± 0.03
BK 0603TM800-T	RoHS	80	±25%	100	0.18	450	0.30 ±0.03
BK 0603TM121-T	RoHS	120	±25%	100	0.23	400	0.30 ±0.03
BK 0603TM241-T	RoHS	240	±25%	100	0.38	300	0.30 ±0.03
BK 0603TM601-T	RoHS	600	±25%	100	0.85	250	0.30 ±0.03

BK 1005

Parts number	EHS	Nominal impedance [Ω]	Impedance tolerance	Measuring frequency [MHz]	DC Resistance $[\Omega]$ (max.)	Rated current [mA] (max.)	Thickness [mm]
BK 1005HW680-T	R₀HS	68	±25%	100	0.17	500	0.50 ±0.05
BK 1005HW121-T	R₀HS	120	±25%	100	0.24	450	0.50 ±0.05
BK 1005HW241-T	RoHS	240	±25%	100	0.31	400	0.50 ±0.05
BK 1005HW431-T	RoHS	430	±25%	100	0.50	350	0.50 ±0.05
BK 1005HW601-T	RoHS	600	±25%	100	0.60	300	0.50 ±0.05
BK 1005HS100-T	RoHS	10	±5	100	0.03	1,000	0.50 ±0.05
BK 1005HS330-T	RoHS	33	±25%	100	0.06	700	0.50 ±0.05
BK 1005HS680-T	RoHS	68	±25%	100	0.10	700	0.50 ±0.05
BK 1005HS800-T	RoHS	80	±25%	100	0.10	700	0.50 ±0.05
BK 1005HS121-T	RoHS	120	±25%	100	0.20	500	0.50 ±0.05
BK 1005HS241-T	RoHS	240	±25%	100	0.30	400	0.50 ±0.05
BK 1005HS431-T	R₀HS	430	±25%	100	0.45	350	0.50 ±0.05
BK 1005HS601-T	R₀HS	600	±25%	100	0.55	300	0.50 ±0.05
BK 1005HS102-T	RoHS	1000	±25%	100	0.58	300	0.50 ±0.05
BK 1005HR601-T	RoHS	600	±25%	100	0.60	300	0.50 ±0.05
BK 1005HM750-T	RoHS	75	±25%	100	0.18	350	0.50 ±0.05
BK 1005HM121-T	RoHS	120	±25%	100	0.18	300	0.50 ±0.05
BK 1005HM241-T	RoHS	240	±25%	100	0.30	300	0.50 ±0.05
BK 1005HM471-T	RoHS	470	±25%	100	0.45	250	0.50 ±0.05
BK 1005HM601-T	RoHS	600	±25%	100	0.50	250	0.50 ±0.05
BK 1005HM102-T	RoHS	1000	±25%	100	0.70	150	0.50 ±0.05
BK 1005LL100-T	RoHS	10	±25%	100	0.11	500	0.50 ±0.05
BK 1005LL220-T	RoHS	22	±25%	100	0.18	400	0.50 ±0.05
BK 1005LL330-T	RoHS	33	±25%	100	0.25	400	0.50 ±0.05
BK 1005LL470-T	RoHS	47	±25%	100	0.33	350	0.50 ±0.05
BK 1005LL680-T	RoHS	68	±25%	100	0.31	400	0.50 ±0.05
BK 1005LL121-T	RoHS	120	±25%	100	0.45	350	0.50 ±0.05
BK 1005LL181-T	RoHS	180	±25%	100	0.50	300	0.50 ±0.05
BK 1005LL241-T	RoHS	240	±25%	100	0.70	250	0.50 ±0.05
BK 1005LM182-T	RoHS	1800	±25%	100	0.90	120	0.50 ±0.05
BKH1005LM601-T	RoHS	600	±25%	100	0.85	300	0.50 ±0.05
BKH1005LM102-T	RoHS	1000	±25%	100	1.25	250	0.50 ±0.05
BKH1005LM152-T	RoHS	1500	±25%	100	1.50	200	0.50 ±0.05
BKH1005LM182-T	R₀HS	1800	±25%	100	2.00	200	0.50 ±0.05

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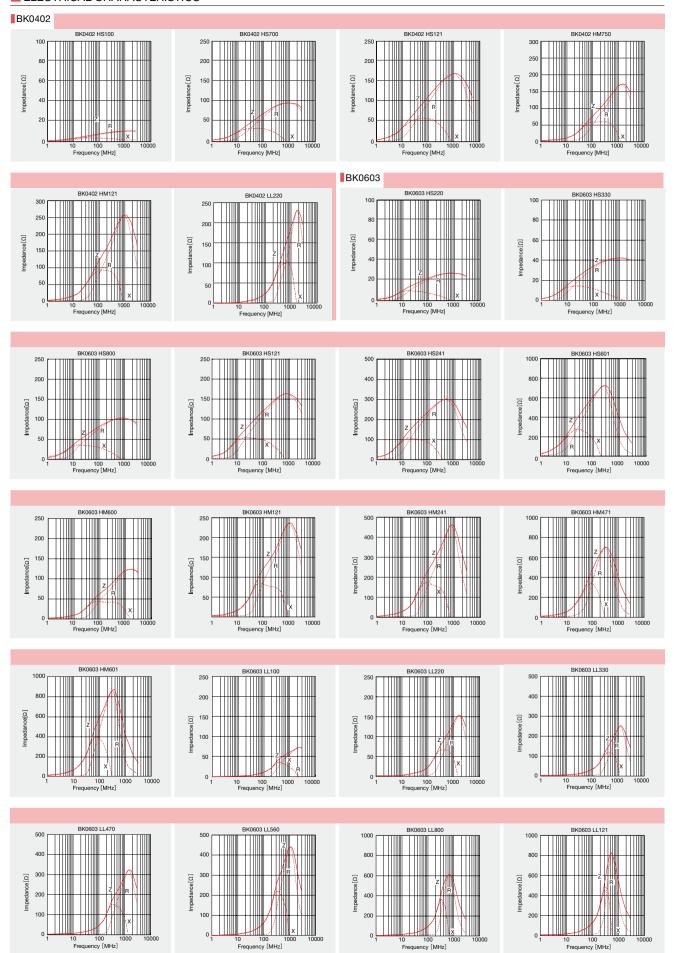
BK 1608

BK 1908							
Parts number	EHS	Nominal impedance [Ω]	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [mA] (max.)	Thickness [mm]
BK 1608HW121-T	R ₀ HS	120	±25%	100	0.15	600	0.80 ±0.15
BK 1608HW241-T	R ₀ HS	240	±25%	100	0.25	450	0.80 ±0.15
BK 1608HW431-T	R ₀ HS	430	±25%	100	0.30	400	0.80 ±0.15
BK 1608HW601-T	R ₀ HS	600	±25%	100	0.40	300	0.80 ±0.15
BK 1608HS220-T	RoHS	22	±25%	100	0.05	1,500	0.80 ±0.15
BK 1608HS330-T	R ₀ HS	33	±25%	100	0.08	1,200	0.80 ±0.15
BK 1608HS470-T	R ₀ HS	47	±25%	100	0.10	900	0.80 ±0.15
BK 1608HS600-T	R ₀ HS	60	±25%	100	0.10	800	0.80 ±0.15
BK 1608HS800-T	R ₀ HS	80	±25%	100	0.10	600	0.80 ±0.15
BK 1608HS121-T	RoHS	120	±25%	100	0.18	500	0.80 ±0.15
BK 1608HS241-T	RoHS	240	±25%	100	0.25	400	0.80 ±0.15
BK 1608HS601-T	R ₀ HS	600	±25%	100	0.45	350	0.80 ±0.15
BK 1608HS102-T	R ₀ HS	1000	±25%	100	0.60	300	0.80 ±0.15
BK 1608HM121-T	R ₀ HS	120	±25%	100	0.20	350	0.80 ±0.15
BK 1608HM241-T	R₀HS	240	±25%	100	0.35	300	0.80 ±0.15
BK 1608HM471-T	R ₀ HS	470	±25%	100	0.45	250	0.80 ±0.15
BK 1608HM601-T	RoHS	600	±25%	100	0.60	250	0.80 ±0.15
BK 1608HM102-T	RoHS	1000	±25%	100	0.70	200	0.80 ±0.15
BK 1608LL300-T	R ₀ HS	30	±25%	100	0.20	500	0.80 ±0.15
BK 1608LL470-T	R ₀ HS	47	±25%	100	0.30	400	0.80 ±0.15
BK 1608LL560-T	R ₀ HS	56	±25%	100	0.30	400	0.80 ±0.15
BK 1608LL680-T	R ₀ HS	68	±25%	100	0.35	300	0.80 ±0.15
BK 1608LL121-T	R ₀ HS	120	±25%	100	0.50	300	0.80 ±0.15
BK 1608LL181-T	R₀HS	180	±25%	100	0.65	250	0.80 ± 0.15
BK 1608LL241-T	R ₀ HS	240	±25%	100	0.80	250	0.80 ± 0.15
BK 1608LL331-T	R ₀ HS	330	±25%	100	0.85	200	0.80 ±0.15
BK 1608LL431-T	R ₀ HS	430	±25%	100	0.85	200	0.80 ±0.15
BK 1608LL511-T	R ₀ HS	510	±25%	100	0.90	200	0.80 ±0.15
BK 1608LL681-T	R ₀ HS	680	±25%	100	1.00	150	0.80 ±0.15
BK 1608LM751-T	R ₀ HS	750	±25%	100	0.60	300	0.80 ±0.15
BK 1608LM152-T	R₀HS	1500	±25%	100	0.75	250	0.80 ± 0.15
BK 1608LM182-T	R₀HS	1800	±25%	100	0.85	200	0.80 ±0.15
BK 1608LM252-T	R₀HS	2500	±25%	100	1.10	200	0.80 ±0.15
BK 1608TS431-T	R₀HS	430	±25%	100	0.21±30%	400	0.80 ±0.15
BK 1608TS601-T	R ₀ HS	600	±25%	100	0.27±30%	350	0.80 ±0.15
BK 1608TS102-T	R ₀ HS	1000	±25%	100	0.30±30%	300	0.80 ±0.15

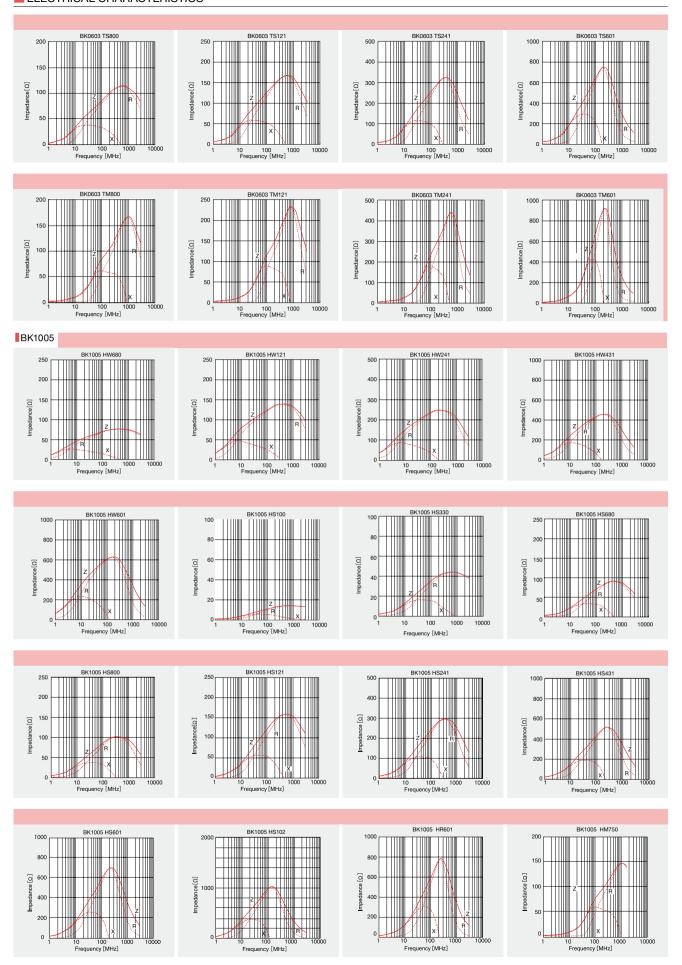
BK 2125

Parts number	EHS	Nominal impedance [Ω]	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω] (max.)	Rated current [mA] (max.)	Thickness [mm]
BK 2125HS150-T	RoHS	15	±25%	100	0.05	1,200	0.85 ±0.2
BK 2125HS220-T	RoHS	22	±25%	100	0.05	1,200	0.85 ±0.2
BK 2125HS330-T	RoHS	33	±25%	100	0.05	1,200	0.85 ±0.2
BK 2125HS470-T	RoHS	47	±25%	100	0.05	1,000	0.85 ±0.2
BK 2125HS750-T	RoHS	75	±25%	100	0.10	1,000	0.85 ±0.2
BK 2125HS101-T	RoHS	100	±25%	100	0.10	900	0.85 ±0.2
BK 2125HS121-T	RoHS	120	±25%	100	0.15	800	0.85 ±0.2
BK 2125HS241-T	RoHS	240	±25%	100	0.20	600	0.85 ±0.2
BK 2125HS431-T	RoHS	430	±25%	100	0.25	500	0.85 ±0.2
BK 2125HS601-T	RoHS	600	±25%	100	0.30	500	0.85 ±0.2
BK 2125HS102-T	RoHS	1000	±25%	100	0.40	300	0.85 ±0.2
BK 2125HM121-T	RoHS	120	±25%	100	0.15	800	0.85 ±0.2
BK 2125HM241-T	RoHS	240	±25%	100	0.20	600	0.85 ±0.2
BK 2125HM471-T	RoHS	470	±25%	100	0.25	500	0.85 ±0.2
BK 2125HM601-T	RoHS	600	±25%	100	0.25	500	0.85 ±0.2
BK 2125HM102-T	RoHS	1000	±25%	100	0.35	400	0.85 ±0.2
BK 2125LL560-T	RoHS	56	±25%	100	0.20	600	0.85 ±0.2
BK 2125LL121-T	RoHS	120	±25%	100	0.30	400	0.85 ±0.2
BK 2125LL241-T	RoHS	240	±25%	100	0.35	300	0.85 ±0.2
BK 2125LM751-T	RoHS	750	±25%	100	0.30	400	0.85 ±0.2
BK 2125LM152-T	RoHS	1500	±25%	100	0.35	400	0.85 ±0.2
BK 2125LM182-T	RoHS	1800	±25%	100	0.45	300	1.25 ±0.2
BK 2125LM252-T	RoHS	2500	±25%	100	0.75	200	1.25 ±0.2

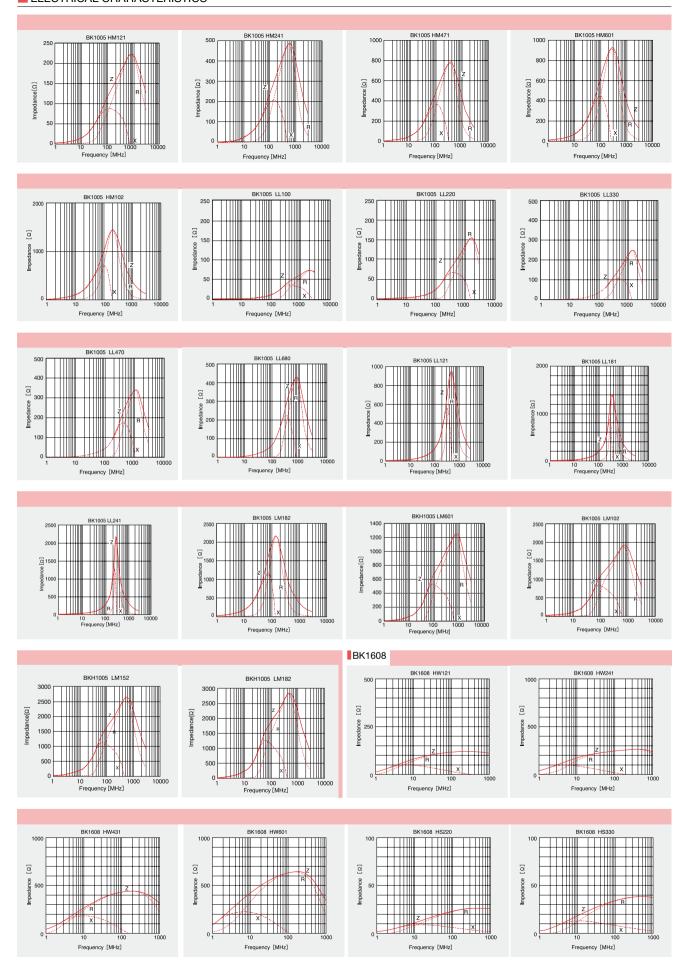
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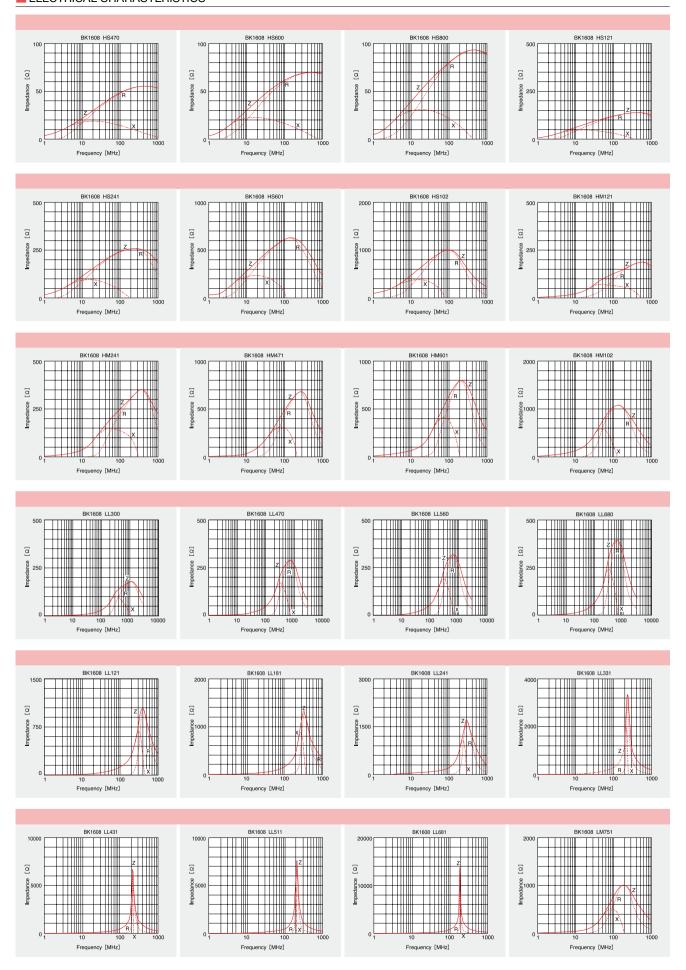
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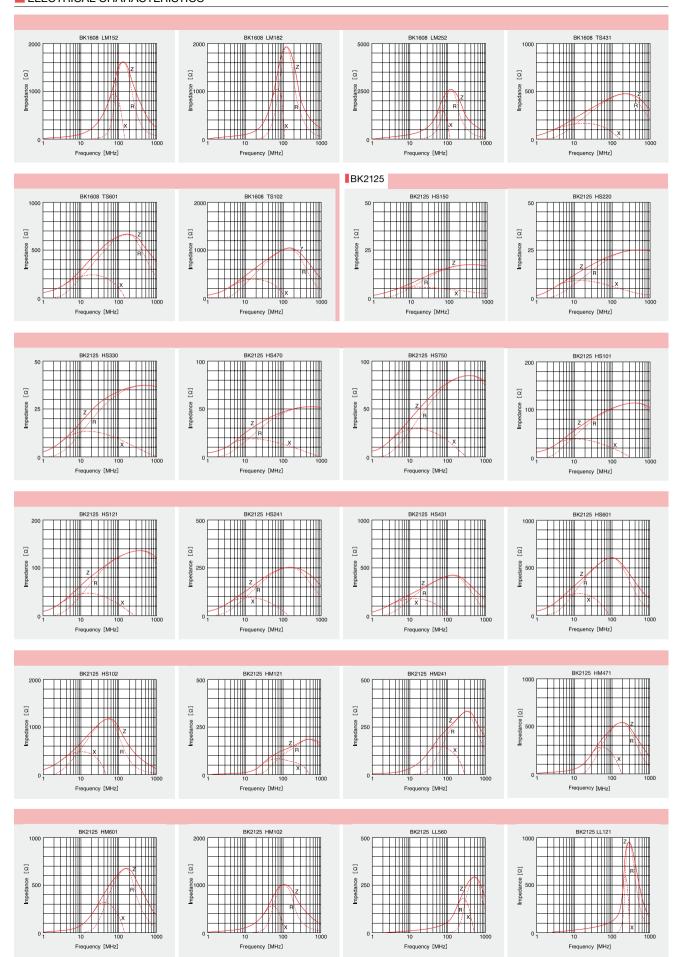
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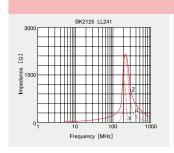
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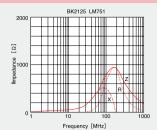


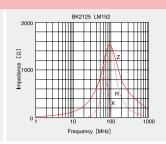
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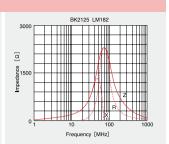


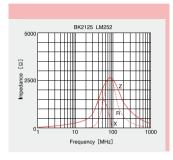
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Multilayer chip inductors Multilayer chip inductors for high frequency, Multilayer chip bead inductors Multilayer common mode choke coils (MC series F type)

■PACKAGING

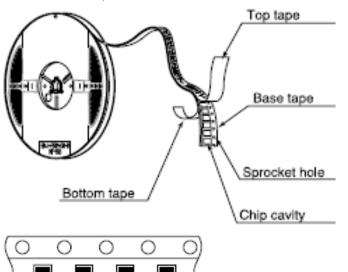
1 Minimum Quantity

Tape & Reel Packaging			
Type	Thickness	Standard Q	uantity [pcs]
Туре	mm(inch)	Paper Tape	Embossed Tape
CK1608(0603)	0.8 (0.031)	4000	_
CK2125 (0805)	0.85(0.033)	4000	_
ONZ123 (0803)	1.25 (0.049)	_	2000
CKS2125 (0805)	0.85(0.033)	4000	_
UN32123 (0803)	1.25 (0.049)	_	2000
CKP1608(0603)	0.8 (0.031)	4000	_
CKP2012(0805)	0.9 (0.035)	_	3000
CKP2016 (0806)	0.9 (0.035)	_	3000
	0.7 (0.028)	_	3000
CKP2520(1008)	0.9 (0.035)	_	3000
	1.1 (0.043)	_	2000
NM2012 (0805)	0.9 (0.035)	_	3000
NM2520(1008)	1.1 (0.043)	_	2000
LK1005(0402)	0.5 (0.020)	10000	_
LK1608(0603)	0.8 (0.031)	4000	_
1 K010E (000E)	0.85(0.033)	4000	_
LK2125(0805)	1.25(0.049)	_	2000
HK0402(01005)	0.2 (0.008)	20000	_
HK0603(0201)	0.3 (0.012)	15000	_
HK1005(0402)	0.5 (0.020)	10000	_
HK1608(0603)	0.8 (0.031)	4000	_
HK2125 (0805)	0.85 (0.033)	_	4000
HK2123(0003)	1.0 (0.039)	_	3000
HKQ0402(01005)	0.2 (0.008)	20000	40000
HKQ0603W(0201)	0.3 (0.012)	15000	_
HKQ0603S(0201)	0.3 (0.012)	15000	_
HKQ0603U(0201)	0.3 (0.012)	15000	_
AQ105(0402)	0.5 (0.020)	10000	_
BK0402(01005)	0.2 (0.008)	20000	_
BK0603(0201)	0.3 (0.012)	15000	_
BK1005(0402)	0.5 (0.020)	10000	_
BKH1005(0402)	0.5 (0.020)	10000	_
BK1608(0603)	0.8 (0.031)	4000	_
BK2125(0805)	0.85(0.033)	4000	_
BK2123(0003)	1.25 (0.049)	_	2000
BK2010(0804)	0.45(0.018)	4000	_
BK3216(1206)	0.8 (0.031)	_	4000
BKP0603(0201)	0.3 (0.012)	15000	_
BKP1005(0402)	0.5 (0.020)	10000	_
BKP1608 (0603)	0.8 (0.031)	4000	_
BKP2125(0805)	0.85 (0.033)	4000	_
MCF0806(0302)	0.4 (0.016)	_	10000
MCF1210(0504)	0.55(0.022)	_	5000
MCF2010(0804)	0.45(0.018)	_	4000

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②Taping material

Card board carrier tape

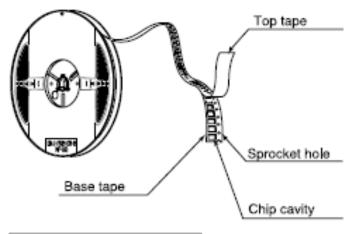


CK	1608	
CKP	1608	
CK	2125	
CKS	2125	
LK	1005	
LK	1608	
LK	2125	
HK	0402	
HK	0603	
HK	1005	
HK	1608	
HKQ	0402	
HKQ	0603	
AQ	105	

BK	0402	
BK	0603	
BK	1005	
BK	1608	
BK	2125	
BK	2010	
BKP	0603	
BKP	1005	
BKP	1608	
BKP	2125	
BKH	1005	
	•	

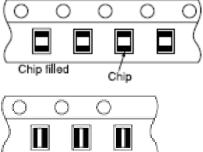
Embossed Tape

Chip filled



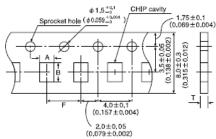
CK	2125	
CKS	2125	
CKP	2012	
CKP	2016	
CKP	2520	
NM	2012	
NM	2520	
LK	2125	
HKQ	0402	
HK	2125	

BK	2125
BK	3216
MCF	0806
MCF	1210
MCF	2010



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Paper tape (0.315 inches wide)



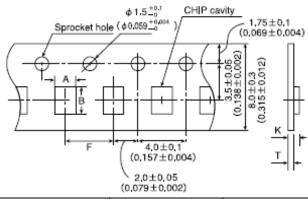
Unit: mm(inch)

(0.079±0.002)		Unit : mm (inch)			
Туре	Thickness	Chip	cavity	Insertion Pitch	Tape Thickness
Туре	mm(inch)	Α	В	F	Т
OK1600 (0602)	0.0 (0.001)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
CK1608(0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
01(0105(0005)	0.05(0.000)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
CK2125 (0805)	0.85 (0.033)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
	/>	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
CKS2125 (0805)	0.85 (0.033)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
		1.0±0.2	1.8±0.2	4.0±0.1	1.1max
CKP1608 (0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
		0.65±0.1	1.15±0.1	2.0±0.05	0.8max
LK1005(0402)	0.5 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
		1.0±0.2	1.8±0.2	4.0±0.1	1.1max
LK1608(0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
		1.5±0.2	2.3±0.2	4.0±0.1	1.1max
LK2125 (0805)	0.85(0.033)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
		0.25±0.04	0.45±0.04	2.0±0.05	0.36max
(0402(01005) 0.2	0.2 (0.008)	(0.010 ± 0.002)	(0.018 ± 0.002)	(0.079 ± 0.002)	(0.014max)
		, ,	· · · · · · · · · · · · · · · · · · ·		' '
HK0603(0201)	0.3 (0.012)	0.40 ± 0.06	0.70 ± 0.06	2.0±0.05	0.45max
		(0.016±0.002)	(0.028±0.002)	(0.079±0.002)	(0.018max)
HK1005(0402)	0.5 (0.020)	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
, ,		(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
HK1608 (0603) 0.8	0.8 (0.031)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
		(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
HKQ0402(01005) 0.2 (0.2 (0.008)	0.25 ± 0.04	0.45 ± 0.04	2.0 ± 0.05	0.36max
	0.2 (0.000)	(0.010 ± 0.002)	(0.018 ± 0.002)	(0.079 ± 0.002)	(0.01max)
IKQ0603W(0201) 0.3 (0.0	0.3 (0.012)	0.40 ± 0.06	0.70 ± 0.06	2.0±0.05	0.45max
	0.5 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
IKO06036 (0001)	0.2 (0.010)	0.40±0.06	0.70 ± 0.06	2.0±0.05	0.45max
HKQ0603S(0201)	0.3 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
(0.00011/0001)	0.0 (0.010)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HKQ0603U(0201)	0.3 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018mx)
		0.75±0.1	1.15±0.1	2.0±0.05	0.8max
AQ105(0402)	0.5 (0.020)	(0.030 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
		0.25±0.04	0.45±0.04	2.0±0.05	0.36max
BK0402(01005)	0.2 (0.008)	(0.010 ± 0.002)	(0.018 ± 0.002)	(0.079 ± 0.002)	(0.014max)
		0.40±0.06	0.70±0.06	2.0±0.05	0.45max
BK0603(0201)	0.3 (0.012)	(0.016±0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
		0.65±0.1	1.15±0.1	2.0±0.05	0.8max
BK1005(0402)	0.5 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
		1.0±0.2	1.8±0.2	4.0±0.1	1.1max
BK1608(0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157±0.004)	(0.043max)
BK2125(0805)	0.85(0.033)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
		(0.059±0.008)	(0.091±0.008)	(0.157±0.004)	(0.043max)
BK2010(0804)	0.45(0.018)	1.2±0.1	2.17±0.1	4.0±0.1	0.8max
		(0.047±0.004)	(0.085 ± 0.004)	(0.157±0.004)	(0.031max)
BKP0603(0201)	0.3 (0.012)	0.40 ± 0.06	0.70±0.06	2.0±0.05	0.45max
	0.0 (0.0.2)	(0.016±0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
3KP1005 (0402)	0.5 (0.020)	0.65 ± 0.1	1.15±0.1	2.0 ± 0.05	0.8max
51.1 1000 (0-102)	0.0 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
DKD1600 (0603)	0.0 (0.031)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
BKP1608 (0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
DKD010E (000E)	0.05(0.000)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
BKP2125 (0805)	0.85(0.033)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
DI((14005 (2225)	0.5 (0.000)	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
BKH1005(0805)	0.5 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)

Unit: mm(inch)

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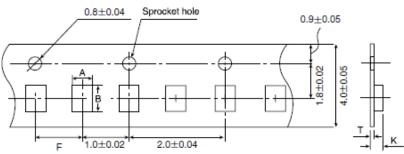
Embossed Tape (0.315 inches wide)



Туре	Thickness	Chip	cavity	Insertion Pitch	Tape Thickness	
туре	mm(inch)	Α	В	F	K	Т
CK2125(0805)	1.05(0.040)	1.5±0.2	2.3±0.2	4.0±0.1	2.0	0.3
CK2123(0803)	1.25(0.049)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.079)	(0.012)
CKS2125(0805)	1.25(0.049)	1.5±0.2	2.3±0.2	4.0±0.1	2.0	0.3
GK32123(0003)	1.25(0.049)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.079)	(0.012)
CKP2012(0805)	0.9 (0.035)	1.55±0.2	2.3±0.2	4.0±0.1	1.3	0.3
GRP2012 (0003)	0.9 (0.033)	(0.061 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.051)	(0.012)
CKP2016 (0806)	0.9 (0.035)	1.8±0.1	2.2±0.1	4.0±0.1	1.3	0.25
CKP2010 (0800)	0.9 (0.035)	(0.071 ± 0.004)	(0.087 ± 0.004)	(0.157 ± 0.004)	(0.051)	(0.01)
	0.7 (0.028)				1.4	
	0.7 (0.028)				(0.055)	
CKP2520(1008)	0.9 (0.035)	2.3 ± 0.1	2.8±0.1	4.0 ± 0.1	1.4	0.3
GRP2020(1006)	0.9 (0.033)	(0.091 ± 0.004)	(0.110 ± 0.004)	(0.157 ± 0.004)	(0.055)	(0.012)
	1.1 (0.043)				1.7	
					(0.067)	
NIN40040 (000E)	0.9 (0.035)	1.55±0.2	2.3±0.2	4.0±0.1	1.3	0.3
NM2012 (0805)	0.9 (0.035)	(0.061 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.051)	(0.012)
NIMOTOO (1000)	1.1 (0.042)	2.3±0.1	2.8±0.1	4.0±0.1	1.7	0.3
NM2520 (1008)	1.1 (0.043)	(0.091 ± 0.004)	(0.110 ± 0.004)	(0.157 ± 0.004)	(0.067)	(0.012)
11(0105(0005)	1.25(0.049)	1.5±0.2	2.3±0.2	4.0±0.1	2.0	0.3
LK2125 (0805)	1.25(0.049)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.079)	(0.012)
	0.85(0.033)				1.5	
HK2125(0805)		1.5±0.2	2.3±0.2	4.0 ± 0.1	(0.059)	0.3
HK2123(0803)	1.0 (0.039)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	2.0	(0.012)
	1.0 (0.039)				(0.079)	
DK010E (000E)	1.25(0.049)	1.5±0.2	2.3±0.2	4.0±0.1	2.0	0.3
BK2125(0805)	1.25(0.049)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.079)	(0.012)
DK0010(1000)	0.8(0.031)	1.9±0.1	3.5±0.1	4.0±0.1	1.4	0.3
BK3216(1206)	0.8(0.031)	(0.075 ± 0.004)	(0.138 ± 0.004)	(0.157 ± 0.004)	(0.055)	(0.012)
MOE0000(0000)	0.4 (0.010)	0.75±0.05	0.95±0.05	2.0±0.05	0.55	0.3
MCF0806(0302)	0.4 (0.016)	(0.030 ± 0.002)	(0.037 ± 0.002)	(0.079 ± 0.002)	(0.022)	(0.012)
MOE1010(0E04)	0.55 (0.000)	1.15±0.05	1.40±0.05	4.0±0.1	0.65	0.3
MCF1210(0504)	0.55(0.022)	(0.045 ± 0.002)	(0.055 ± 0.002)	(0.157 ± 0.004)	(0.026)	(0.012)
MOE0040(0004)	0.45(0.040)	1.1±0.1	2.3±0.1	4.0±0.1	0.85	0.3
MCF2010(0804)	0.45(0.018)	(0.043 ± 0.004)	(0.091 ± 0.004)	(0.157 ± 0.004)	(0.033)	(0.012)

Unit: mm(inch)

Embossed Tape (0.157 inches wide)

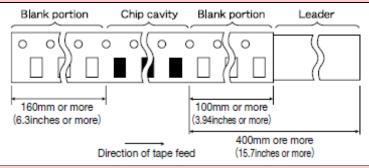


Tyme	Thickness	Chip cavity		Chip cavity Insertion Pitch		Tape Thickness	
Туре	mm(inch)	Α	В	F	K	Т	
HKQ0402(01005)	0.2 (0.008)	0.23	0.43	1.0±0.02	0.5max.	0.25max.	

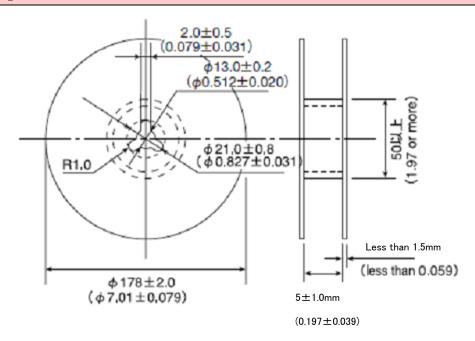
Unit: mm(inch)

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4LEADER AND BLANK PORTION

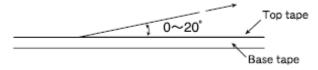


⑤Reel Size



6Top tape strength

The top tape requires a peel-off force of $0.1 \sim 0.7 N$ in the direction of the arrow as illustrated below.



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Multilayer chip inductors Multilayer chip inductors for high frequency, Multilayer chip bead inductors Multilayer common mode choke coils (MC series F type)

RELIABILITY DATA

1. Operating Temp	-				
	BK0402		_		
	BK0603		_		
	BK1005		_		
	BKH1005				
	BK1608		_		
	BK2125	DICOGIO	- 		
	ARRAY	BK2010 BK3216			
	BKP0603	BN3210			
	BKP1005		-		
	BKP1608				
	BKP1008				
	MCF 0806				
	MCF 1210		-40~+85°C		
	MCF 1210 MCF 2010				
	CK1608				
	CK2125				
Specified Value	CKS2125				
	CKP1608		_		
	CKP2012		_		
	CKP2016		10. 10.00		
	CKP2520		── -40~+85°C		
	NM2012				
	NM2520				
	LK1005				
	LK1608		7		
	LK2125				
	HK0402/HK	Q0402			
	HK0603				
	HK1005				
	HK1608		-40~+85°C		
	HK2125		10 1000		
	HKQ0603W/	HKQ0603S/HKQ0603U			
	AQ105				

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2. Storage Temper	_				
	BK0402				
	BK0603				
	BK1005				
	BKH1005				
	BK1608				
	BK2125				
	ARRAY	BK2010 BK3216			
	BKP0603	•			
	BKP1005		FF 1.05°O		
	BKP1608				
	BKP2125				
	MCF 0806				
	MCF 1210		-40~+85°C		
	MCF 2010				
	CK1608				
Specified Value	CK2125				
Specified value	CKS2125				
	CKP1608				
	CKP2012				
	CKP2016		-40~+85°C		
	CKP2520				
	NM2012				
	NM2520				
	LK1005				
	LK1608				
	LK2125				
	HK0402/HKQ	0402			
	HK0603				
	HK1005				
	HK1608		-40∼+85°C		
	HK2125				
		IKQ0603S/HKQ0603U			
	AQ105		00 1 120 0		

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3. Rated Current	ated Current					
	BK0402		240~540mA DC			
	BK0603		100~500mA DC			
	BK1005		120~1000mA DC			
	BKH1005		200mA DC			
	BK1608		150~1500mA DC			
	BK2125		200~1200mA DC			
	ARRAY	BK2010	100mA DC			
	ARRAT	BK3216	100~200mA DC			
	BKP0603		1.0A DC			
	BKP1005		800~2000mA DC			
	BKP1608		1.0∼3.0A DC			
	BKP2125		1.5~4.0A DC			
	MCF 0806		0.1~0.13A DC			
	MCF 1210		0.1A DC			
	MCF 2010		0.1A DC			
	CK1608		50~60mA DC			
	CK2125		60~500mA DC			
	CKS2125		110~280mA DC			
Specified Value	CKP1608		0.35~0.9A DC			
	CKP2012		0.7~1.2A DC			
	CKP2016		0.9~1.6A DC			
	CKP2520		1.1~1.8A DC			
	NM2012		0.8~1.5A DC			
	NM2520		0.9~1.1A DC			
	LK1005		20~25mA DC			
	LK1608		1~150mA DC			
	LK2125		5~300mA DC			
	HK0402		160~380mA DC			
	HK0603		60~470mA DC			
	HK1005		110~300mA DC			
	HK1608		150~300mA DC			
	HK2125		300mA DC			
	HKQ0402		90~500mA DC			
	HKQ0603W		160~850mA DC			
	HKQ0603S		130~600mA DC			
	HKQ0603U		130~600mA DC			
	AQ105		280~710mA DC			

Definition of rated current:

- •In the CK, CKS and BK Series, the rated current is the value of current at which the temperature of the element is increased within 20°C.
- •In the BK Series P type and CK Series P type, NM Series the rated current is the value of current at which the temperature of the element is increased within 40°C.
- •In the LK, HK, HKQ, and AQ Series, the rated current is either the DC value at which the internal L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20°C.

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4 7 1			
4. Impedance	DIKO 400		10, 1000, 1000
	BK0402		10~120Ω ±25%
	BK0603		10~600Ω ±25%
	BK1005		10~1800Ω ±25%
	BKH1005		1500~1800Ω ±25%
	BK1608		22~2500Ω ±25%
	BK2125	′2010	$15\sim2500 \Omega \pm 25\%$ $5\sim1000 \Omega \pm 25\%$
	I ARRAY —	(2010 (3216	5~1000Ω ±25% 68~1000Ω ±25%
	BKP0603	VOZ 10	68~1000 \(100 \text{100 \t
	BKP0603 BKP1005		22~33Ω ±25% 10~220Ω ±25%
	BKP1608		33~470Ω ±25%
	BKP2125		33~330Ω ±25%
	MCF 0806		$12\sim90\Omega$ $\pm5\Omega(12\Omega)$, $\pm20\%(Other)$
	MCF 0806 MCF 1210		$12 \sim 90 \Omega \pm 5 \Omega (12 \Omega), \pm 20\% (Other)$ $90 \Omega \pm 25\%$
	MCF 1210 MCF 2010		90\times \frac{\pi}{2} \frac{\pi}{25\%}
	CK1608		
	CK2125		1
Specified Value	CKS2125		1
	CK92123 CKP1608		1
	CKP1608 CKP2012		1
	CKP2012 CKP2016		1
	CKP2016 CKP2520		1
	NM2012		1
	NM2520		1
	LK1005		<u> </u>
	LK1608		1
	LK2125		1
	HK0402/HKQ0402		
	HK0603		
	HK1005		
	HK1608		
	HK2125		
	HKQ0603W/HKQ06	03S/HKQ0603U	
	AQ105		
_	BK0402Series	_	
	Measuring frequen	=	
	Measuring equipme		
	Measuring jig	: 16196D (or its e	equivalent)
	BK0603Series, BKP Measuring frequen		
	Measuring frequen Measuring equipme	-	uivalent)
	Measuring equipme	: 16193A(or its eq	
	000	P1005Series ,BKH1005Seri	•
Test Methods and	Measuring frequen		
Remarks	Measuring equipme	•	juivalent)
	Measuring jig		equivalent), 16193A(or its equivalent)
	BK1608 • 2125Series	s, BKP1608 • 2125Series	
	Measuring frequen		
	Measuring equipme		quivalent), 4195A(or its equivalent)
	Measuring jig		equivalent) or 16192A(or its equivalent)/HW
	BK2010 • 3216Series		
	Measuring frequen		uivalent) 4105A (or its savivalent)
	Measuring equipme Measuring jig	ent : 4291A(or its eq : 16192A(or its e	quivalent), 4195A(or its equivalent)
	weasuring jig	. IUIBZA(Or ITS E	Equivalent/

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BK0402		
BK0603		
BK1005		
BKH1005		
BK1608		
BK2125		
ARRAY BK2010 BK3216		_
BKP0603		
BKP1005		
BKP1608		
BKP2125		
MCF 0806		
MCF 1210		
MCF 2010		
CK1608		4.7~10.0 μ H: ±20%
CK2125		0.1~10.0 μ H: ±20%
		1.0~10.0 μ H: ±20%
CKP1608		$0.33 \sim 2.2 \mu\text{H}$: $\pm 20\%$
CKP2012		$0.47 \sim 4.7 \mu \text{H}$: $\pm 20\%$
		$0.47 \sim 4.7 \mu \text{ H}$: $\pm 20\%$
		$0.47 \sim 4.7 \mu$ H: $\pm 20\%$
		0.82~1.0 µ H: ±20% 1.0~2.2 µ H: ±20%
		Inductance 0.12~2.2 μ H: ±10%, Q 0.12~2.2 μ H: ±30%
EKTOOS		Inductance 0.047~33.0 \(\mu\) H: \(\pm 2.0\) \(\mu\) \
LK1608		Q 0.12~2.2 \(\mu\) H: \(\pm\)30%
		Inductance $0.047 \sim 33.0 \mu\text{H}$: $\pm 20\%$ $0.10 \sim 12.0 \mu\text{H}$: $\pm 10\%$
LK2125		Q 0.12~2.2 \(\mu \) H: \(\pm \) 30%
HK0402		1.0~6.2nH: ±0.3nH 6.8~12nH: ±5%
HK0603		1.0~6.2nH: ±0.3nH 6.8~100nH: ±5%
HK1005		1.0~6.2nH: ±0.3nH 6.8~270nH: ±5%
HK1608		1.0~5.6nH: ±0.3nH 6.8~470nH: ±5%
HK2125		1.5~5.6nH: ±0.3nH 6.8~470nH: ±5%
HKQ0402		0.5~5.6nH: ±0.3nH 6.2~27nH: ±5%
HKQ0603W		0.6~3.9nH: ±0.3nH 4.3~22nH: ±5%
HKQ0603S		0.6~6.2nH: ±0.3nH 6.8~22nH: ±5%
HKQ0603U		0.6~6.2nH: ±0.3nH 6.8~22nH: ±5%
AQ105		1.0∼6.2nH: ±0.3nH 6.8∼15nH: ±5%
	0 4141 (016	(4000)
= : :		
= : :		
= : :	. Z TWITE ON	(CE 120)
Measuring frequency	: 10~25MHz(I	LK1005)
Measuring frequency	: 1~50MHz(Ll	
Measuring frequency	: 0.4~50MHz(LK2125)
CKP, NMSeries		
Measuring frequency		012 • CKP2016 • CKP2520 • NM2012 • NM2520)
Measuring equipment /jig		85B+16092A(or its equivalent)
		1951 + 16092A (or its equivalent)
d		92A(or its equivalent) A(or its equivalent)/LK1005
		241A+42842C+42851-61100(CKP2012•CKP2016•CKP2520•NM2012•NM2520)
Measuring current	:•1mA rms(0.0	
_	•0.1mA rms(•
HK, HKQ, AQ Series		
		402 · HKQ0402 · HK0603 · HK1005 · AQ105)
Measuring frequency		
Measuring frequency Measuring frequency	: 50/100MHz(I	
Measuring frequency Measuring frequency Measuring frequency	: 50/100MHz(I : 500MHz(HKC	Q0402 • HKQ0603S • HKQ0603U)
Measuring frequency Measuring frequency Measuring frequency Measuring frequency	: 50/100MHz(I : 500MHz(HKG : 300/500MHz	Q0402+HKQ0603S+HKQ0603U) (HKQ0603W)
Measuring frequency Measuring frequency Measuring frequency	: 50/100MHz(I : 500MHz(HKG : 300/500MHz :•4291A+1619	Q0402+HKQ0603S+HKQ0603U) (HKQ0603W) 97A(or its equivalent)/HK060+AQ105
Measuring frequency Measuring frequency Measuring frequency Measuring frequency	: 50/100MHz(I : 500MHz(HKG : 300/500MHz :•4291A+1619	Q0402+HKQ0603S+HKQ0603U) (HKQ0603W) 97A(or its equivalent)/HK060+AQ105 93A(or its equivalent)/HK1005
Measuring frequency Measuring frequency Measuring frequency Measuring frequency	: 50/100MHz(IKG : 500MHz(HKG : 300/500MHz : 4291A+1619 • 4291A+161	Q0402+HKQ0603S+HKQ0603U) (HKQ0603W) 97A(or its equivalent)/HK060+AQ105
	BK0603 BK1005 BKH1005 BKH1005 BK1608 BK2125 ARRAY BK2010 BK3216 BKP0603 BKP1005 BKP1608 BKP2125 MCF 0806 MCF 1210 MCF 2010 CK1608 CK2125 CKS2125 CKP1608 CKP2012 CKP2016 CKP2520 NM2012 NM2520 LK1005 LK1608 LK2125 HK0402 HK0603 HK1005 HK1608 HK2125 HKQ0603W HKQ0603W HKQ0603U AQ105 CKSeries Measuring frequency Measuring equipment /jig	BK0603 BK1005 BK1005 BK1005 BK1608 BK2125 ARRAY BK2010 BK216 BKP0603 BKP1005 BKP1608 BKP2125 MCF 0806 MCF 1210 MCF 2010 CK1608 CK2125 CKS2125 CKP1608 CKP2012 CKP2016 CKP2520 NM2012 NM2520 LK1005 LK1608 LK2125 HK0402 HK0603 HK1005 HK1608 HK2125 HKQ0402 HKQ0603W HKQ0603W HKQ0603W HKQ0603W HKQ0603W HKQ0603W AQ105 CKSeries Measuring frequency 2 ~2 MHz (CK Measuring frequency 2 ~4 MH

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6. Q			
U. Q	BK0402		
	BK0603		
	BK1005		
	BKH1005		
	BK1608		
	BK2125		
	BK2010		
	ARRAY BK3216		
			_
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		20 min.
	CK2125		15~20 min.
	CKS2125		
Specified Value	CKP1608		
	CKP2012		
	CKP2016		_
	CKP2520		
	NM2012		
	NM2520		
	LK1005		10~20 min.
	LK1608		10~35 min.
	LK2125		15~50 min.
	HK0402		3 min.
	HK0603		4~5 min.
	HK1005		8 min.
	HK1608		8~12 min.
	HK2125		10~18 min.
	HKQ0402		3~8 min.
	HKQ0603W		14~15 min.
	HKQ0603S		10~13 min. 10~13 min.
	HKQ0603U		
	AQ105		8 min.
	CKSeries	. 0 AMU - (OK16	200)
	Measuring frequency	: 2~4MHz(CK16 : 2~25MHz(CK2	
	Measuring frequency	: 2~25MH2(GR2	2123)
	LKSeries Measuring frequency: 10~25MHz(LK		(1005)
	Measuring frequency : 10~25MHz(LK) Measuring frequency : 1~50MHz(LK)		
	Measuring frequency : 1~50MHz(LK) Measuring frequency : 0.4~50MHz(LK)		
	Measuring equipment /jig : 4194A + 16085		
			I + 16092A(or its equivalent)
			2A (or its equivalent)
			BA (or its equivalent) / LK1005
Test Methods and	Measuring current	•1mA rms(0.04	
Remarks		•0.1mA rms(5.6	5∼33 μ H)
	HK、HKQ、AQ Series		
			02 · HKQ0402 · HK0603 · HK1005 · AQ105)
	Measuring frequency	: 50/100MHz(HK	(1608 • HK2125)
			402 • HKQ0603S • HKQ0603U)
	Measuring frequency	: 300/500MHz(H	
	Measuring equipment /jig		A(or its equivalent)/HK0603•AQ105
			BA(or its equivalent)/HK1005
			7A(or its equivalent)/HKQ0603S+HKQ0603U+HKQ0603W
			2A + in-house made jig(or its equivalent)/HK1608, HK2125
	-E4991A+1619		96D (or its equivalent) HK0402 • HKQ0402

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7. DC Resistance	DK0400		BK0402 0.10~0.53Ω max.						
	BK0603		0.065~1.50 Ω max.						
	BK1005		0.03~0.80Ω max.						
	BKH1005		1.50~2.00Ω max.						
	BK1608		0.05~1.10Ω max.						
	BK2125		0.05~0.75Ω max.						
	ARRAY	BK2010	0.10~0.90Ω max.						
		BK3216	0.15~0.80Ω max.						
	BKP0603		0.065∼0.070Ω max.						
	BKP1005		0.030~0.20Ω max.						
	BKP1608		0.025~0.18Ω max.						
	BKP2125		0.020~0.075Ω max.						
	MCF 0806		2.5∼6.5Ω max.						
	MCF 1210		4.5 Ω max.						
	MCF 2010		4.5 Ω max.						
	CK1608		$0.45 \sim 0.85 \Omega \ (\pm 30\%)$						
	CK2125		0.16~0.65Ω max.						
	01/00105		0.09~0.40 Ω typ.						
	CKS2125		0.12~0.52Ω max.						
Specified Value	CKP1608		0.15~0.35Ω max.						
	CKP2012		0.10~0.28Ω max.						
	CKP2016		0.08~0.20Ω max.						
	CKP2520		0.05~0.16Ω max.						
	NM2012		0.10~0.19Ω max.						
	NM2520		0.13~0.22Ω max.						
	LK1005		0.41~1.16Ω max.						
	LK1608		0.2∼2.2Ω max.						
	LK2125		0.1~1.1Ω max.						
	HK0402		0.18~0.99Ω max.						
	HK0603		0.11~3.74Ω max.						
	HK1005		0.08~4.8Ω max.						
	HK1608		0.05~2.6Ω max.						
	HK2125		0.10~1.5Ω max.						
	HKQ0402		0.08~2.24Ω max.						
	HKQ0603W		0.07~1.6Ω max.						
	HKQ0603S		0.06∼1.29Ω max.						
	HKQ0603U		0.06~1.29 Ω max.						
	AQ105		0.00~1.29 Ω max.						
est Methods and Remarks	Measuring equipment: VOAC-7412 (made by Iwasaki Tsushinki) VOAC-7512 (made by Iwasaki Tsushinki)								

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8. Self Resonance Frequency(SRF)					
S. Son Resonance i	BK0402				
	BK0603				
	BK1005				
	BKH1005				
	BK1608				
	BK2125				
		BK2010			
	ARRAY	BK3216	<u> </u>		
	BKP0603				
	BKP1005				
	BKP1608				
	BKP2125				
	MCF 0806				
	MCF 1210				
	MCF 2010				
	CK1608		17~25MHz min.		
	CK2125		24~235MHz min.		
	CKS2125		24 - 200MH2 HIII.		
Specified Value	CKP1608				
·	CKP2012				
	CKP2016				
	CKP2520				
	NM2012				
	NM2520				
	LK1005		40~180MHz min.		
	LK1608		9∼260MHz min.		
	LK2125		13~320MHz min.		
	HK0402		29000∼10000MHz min.		
	HK0603		900~10000MHz min.		
	HK1005		400~10000MHz min.		
	HK1608		300~10000MHz min.		
	HK2125		200~4000MHz min.		
	HKQ0402		1700∼10000MHz min.		
	HKQ0603W		2500~10000MHz min.		
	HKQ0603S		1900∼10000MHz min.		
	HKQ0603U		1900∼10000MHz min.		
	AQ105		2300~10000MHz min.		
	LKSeries :				
Test Methods and	Measuring equ	uipment : 4195A(or its ed	uivalent)		
Remarks	Measuring jig : 41951+16092A		(or its equivalent)		
, comunity	HK、HKQ、AQSeries:				
	Measuring equ	uipment : 8719C(or its ed	quivalent) •8753D (or its equivalent) /HK2125		

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9. Temperature Ch	aracteristic		
a. Temperature On	BK0402		
	BK0402		-
	BK1005		-
	BKH1005		-
	BK1608		-
	BK2125		-
	BK2010		-
	ARRAY	BK3216	-
	BKP0603	BROZTO	╡
	BKP1005		╡
	BKP1608		╡
	BKP2125		╡
	MCF 0806		╡
	MCF 1210		
	MCF 1210		-
	CK1608		╡
	CK1008 CK2125		╡
	CKS2125		
Specified Value	CKP1608		-
Specified value	CKP2012		_
	CKP2016		7
	CKP2520		7
	NM2012		7
	NM2520		7
	LK1005		7
	LK1608		7
	LK2125		7
	HK0402		
	HK0603		Inductance change: Within ±10%
	HK1005		
	HK1608		
	HK2125		
	HKQ0402		
	HKQ0603W		
	HKQ0603S		
	HKQ0603U		
	AQ105		7
Took Moderner	HK, HKQ, AQ	Series:	
Test Methods and Remarks	Temperature range : −30~+85°C		
nemarks	Reference temperature : +20°C		

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10. Resistance to F	e to Flexure of Substrate					
	BK0402					
	BK0603					
	BK1005					
	BKH1005					
	BK1608					
	BK2125	DIVOOTO				
	ARRAY	BK2010	 			
		BK3216	1			
	BKP0603		1			
	BKP1005					
	BKP1608		1			
	BKP2125					
	MCF 0806					
	MCF 1210					
	MCF 2010					
	CK1608					
	CK2125					
	CKS2125		ł.,. —			
Specified Value	CKP1608		No mechanical damage.			
	CKP2012					
	CKP2016		1			
	CKP2520		1			
	NM2012		1			
	NM2520		1			
	LK1005		1			
	LK1608		1			
	LK2125		-			
	HK0402					
	HK0603					
	HK1005		 			
	HK1608		 			
	HK2125		1			
	HKQ0402		1			
	HKQ0603W		1			
	HKQ0603S					
	HKQ0603U					
	AQ105	0 /51/ 5 :	OMOS - PAR PART OF SAR			
	Warp		0402size, BKP, BKH, CK, CKS, CKP, NM, LK, HK, HKQ0603S, HKQ0603U, AQ Series,			
		MCF1210)	KONANA HKONGOAW Savina MCE Savina without 1910)			
			KQ0402、HKQ0603W Series、MCF Series without 1210 size,)			
	Thickness	: glass epoxy-resin substrat : 0.8mm	uo.			
	I nickness	. 0.011111				
Test Methods and		7				
Remarks	Board R 230	T				
		Warp				
	+ ::					
	V 💢	eviation±1				
	45	45				
	1 1	[Unit: mm]				

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11. Solderability				
Goldor domity	BK0402			
	BK0603			
	BK1005			
	BKH1005			
	BK1608			
	BK2125			
	ARRAY	BK2010	0	
		BK3216		At least 75% of terminal electrode is covered by new solder.
	BKP0603	1		Actions 7070 of communication is devoted by new soluci.
	BKP1005			
	BKP1608			
	BKP2125			
	MCF 0806			
	MCF 1210			
	MCF 2010			
	CK1608			
	CK2125			
	CKS2125			
Specified Value	CKP1608			
	CKP2012			
	CKP2016			
	CKP2520			
	NM2012			
	NM2520			
	LK1005			A. J. 750/ C
	LK1608			
	LK2125			At least 75% of terminal electrode is covered by new solder.
	HK0402			
	HK0603			
	HK1005			
	HK1608			
	HK2125			
	HKQ0402			
	HKQ0603W			
	HKQ0603S			
	HKQ0603U			1
	AQ105			
Test Methods and	Solder tempera	ature	: 230±5°C	
Remarks	Duration		:4±1 sec.	

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12. Resistance to S	Soldering			
	BK0402			
	BK0603			
	BK1005			
	BKH1005			
	BK1608			
	BK2125		Appearance: No significant abnormality	
	BK2010		Impedance change: Within ±30%	
	ARRAY BK3216			
	BKP0603			
	BKP1005			
	BKP1608			
	BKP2125			
	MCF 0806			
	MCF 1210		Appearance: No significant abnormality	
	MCF 2010		Impedance change: Within ±20%	
	CK1608			
	CK2125		No mechanical damage.	
	CKS2125		Remaining terminal electrode: 70% min	
	CKP1608			
	CKP2012		Inductance change	
0 10 11/1	CKP2016		R10~4R7: Within ±10%	
Specified Value	CKP2520		6R8~100: Within ±15% CKS2125: Within ±20% CKP2012, CKP2016, CKP2520, NM2012, NM2520: Within ±30%	
	NM2012			
	NM2520			
			No mechanical damage.	
	LK1005		Remaining terminal electrode: 70% min.	
			Inductance change: Within ±15%	
	LK1608		No mechanical damage.	
			Remaining terminal electrode: 70% min.	
	LK2125		Inductance change	
			47N~4R7: Within ±10%	
	111/0 400		5R6~330: Within ±15%	
	HK0402			
	HK0603 HK1005			
	HK1608			
	HK2125		No mechanical damage.	
			Remaining terminal electrode: 70% min.	
	HKQ0402		Inductance change: Within ±5%	
	HKQ0603W			
	HKQ0603S			
	HKQ0603U			
	AQ105			
	Solder temperature	:260±5°C		
Tark Made 1	Duration	:10±0.5 sec.		
Test Methods and	Preheating temperature :150 to 180°C			
Remarks	Preheating time :3 min.		a methanol colution with colonbony for 3 to 5 coc	
	Flux Recovery		o methanol solution with colophony for 3 to 5 sec. ecovery under the standard condition after the test.(See Note 1)	
	TRECOVERY :2 to 3 hrs of re		Secretary and Standard Condition and test. (Oct 19010-17)	

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13. Thermal Shock						
13. Triermai Shock	BK0402		1			
	BK0603		1			
	BK1005					
	BKH1005					
	BK1608					
	BK2125		Annearance : No.	significant appermality		
		BK2010		Appearance: No significant abnormality Impedance change: Within ±30%		
	ARRAY	BK3216	impodance change. Within 20070			
	BKP0603					
	BKP1005					
	BKP1608					
	BKP2125		1			
	MCF 0806					
	MCF 1210		1	significant abnormality		
	MCF 2010		Impedance chang	e: Within ±20%		
	CK1608		No mechanical da	amage.		
	CK2125		1	ge:Within ±20% Q change:Within ±30%		
	CKS2125		Inductance change: Within ±20% (CKS2125)			
Specified Value	CKP1608					
	CKP2012					
	CKP2016		No mechanical damage.			
	CKP2520		Inductance change: Within ±30%			
	NM2012					
	NM2520					
	LK1005		No mechanical damage.			
	LK1608		Inductance change: Within ±10% Q change: Within ±30%			
	LK2125		and de diange. The minimage of the many and the minimage of th			
	HK0402					
	HK0603					
	HK1005					
	HK1608		No mechanical damage.			
	HK2125					
	HKQ0402 HKQ0603W		Inductance change: Within ±10% Q change: Within ±20%			
			-			
	HKQ0603S					
	HKQ0603U AQ105					
	Conditions for	r 1 cycle	1			
	Step	temperature (°C)		time(min.)		
	1	Minimum operating temperature	ure +0/-3	30±3		
Test Methods and	2	Room temperature		2~3		
Remarks	3	Maximum operating temperati		30±3		
	4	Room temperature		2~3		
	Number of cyc	•				
	Recovery: 2 to	o 3 hrs of recovery under the s	tandard condition a	fter the test.(See Note 1)		

(Note 1) When there are questions concerning measurement result; measurement shall be made after 48 ± 2 hrs of recovery under the standard condition.

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14 Dams Heat/ Co	tondy state)		
14. Damp Heat (S			
	BK0402	_	
	BK0603	_	
	BK1005	_	
	BKH1005	_	
	BK1608	I	
	BK2125	Appearance: No significant abnormality	
	ARRAY BK2010	Impedance change: Within ±30%	
	BK3216		
	BKP0603		
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0806	Appearance: No significant abnormality	
	MCF 1210	Impedance change: Wihin ±20%	
	MCF 2010		
	CK1608	No mechanical damage.	
	CK2125	Inductance change: Within ±20% Q change: Within ±30%	
	CKS2125	Inductance change: Within ±20%	
Specified Value	CKP1608		
Specified value	CKP2012		
	CKP2016	No mechanical damage.	
	CKP2520	Inductance change: Within ±30%	
	NM2012		
	NM2520		
	LK1005	No mechanical damage.	
	LK1608	Inductance change: Within ±10% Q change: Within ±30%	
	LK2125	No mechanical damage.	
		Inductance change: Within ±20% Q change: Within ±30%	
	HK0402		
	HK0603		
	HK1005		
	HK1608		
	HK2125	No mechanical damage.	
	HKQ0402	Inductance change: Within ±10% Q change: Within ±20%	
	HKQ0603W		
	HKQ0603S		
	HKQ0603U		
	AQ105		
	BK, BKP, BKH Series, MCF Series:		
	Temperature :40±2°C		
	Humidity : 90 to 95%RH		
	Duration : $500+24/-0$ hrs		
	Recovery :2 to 3 hrs of recovery ur	der the standard condition after the removal from test chamber.(See Note 1)	
Test Methods and			
Remarks	LK, CK, CKS, CKP, NM, HK, HKQ, AQSe		
	Temperature :40±2°C(LK, CK, CKS.		
	:60±2°C(HK, HKQ, AQ	Series)	
	Humidity :90 to 95%RH		
	Duration :500±12 hrs Recovery :2 to 3 hrs of recovery ur	nder the standard condition after the removal from test chamber.(See Note 1)	
	1.2 to 3 firs of recovery ur	nucl the standard confuction after the removal from test chamber.\See Note 1/	

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15. Loading under [Damp Heat			
	BK0402			
	BK0603		1	
	BK1005		1	
	BKH1005		1	
	BK1608		1	
	BK2125			
	BIXETEO	BK2010	-	
	ARRAY	BK3216	Appearance: No significant abnormality	
	BKP0603		Impedance change: Within ±30%	
	BKP1005		†	
	BKP1608		-	
	BKP2125			
	MCF 0806		+	
	MCF 1210		-	
	MCF 2010		-	
	CK1608		No mechanical damage.	
	CK2125		Inductance change: Within ±20% Q change: Within ±30%	
			No mechanical damage.	
	CKS2125		Inductance change: Within ±20%	
	CKP1608			
Specified Value	CKP2012			
opcomou valac	CKP2016		No mechanical damage.	
	CKP2520		Inductance change: Within ±30%	
	NM2012		-	
	NM2520			
	LK1005		No mechanical damage. Inductance change: Within ±10% Q change: Within ±30%	
	LK1608		No mechanical damage. Inductance change: $0.047\sim12.0\mu\text{H}$: Within $\pm10\%$ $15.0\sim33.0\mu\text{H}$: Within $\pm15\%$ Q change: Within $\pm30\%$	
	LK2125		No mechanical damage. Inductance change: Within ±20% Q change: Within ±30%	
	HK0402			
	HK0603			
	HK1005			
	HK1608			
	HK2125		No mechanical damage.	
	HKQ0402		Inductance change: Within ±10% Q change: Within ±20%	
	HKQ0603W			
	HKQ0603S			
	HKQ0603U			
	AQ105			
	BK, BKP, BKH	Series:		
	Temperature	:40±2°C		
	Humidity	:90 to 95%RH		
	Applied curren			
	Duration : $500+24/-0$ hrs			
Test Methods and	Recovery	-	under the standard condition after the removal from test chamber. (See Note 1)	
Remarks	LK, CK, CKS, CKP, NK, HK, HKQ, AQ Serie			
	Temperature :40±2°C(LK, CK, CK :60±2°C(HK, HKQ, A			
	Humidity	:90 to 95%RH	ng outes/	
	Applied curren			
	Duration :500±12 hrs			
			under the standard condition after the removal from test chamber.(See Note 1)	
Note on standard o		rd condition" referred to here		

Note on standard condition: "standard condition" referred to herein is defined as follows:

5 to $35^{\circ}\!C$ of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of $20\pm2^{\circ}C$ of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure.

Unless otherwise specified, all the tests are conducted under the "standard condition."

(Note 1) Measurement shall be made after 48 ± 2 hrs of recovery under the standard condition.

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16. Loading at High	1 Temperature			
	BK0402			
	BK0603			
	BK1005		-	
	BKH1005 BK1608		-	
			-	
	BK2125		Annayana Na aimifiaant ahnaymality	
	BK2010		Appearance: No significant abnormality。	
	ARRAY	BK3216	Impedance change: Within ±30%	
	BKP0603		-	
	BKP1005		-	
	BKP1608		-	
			-	
	BKP2125			
	MCF 0806		Appearance: No significant abnormality	
	MCF 1210		Impedance change: Within ±20%	
	MCF 2010			
	CK1608		No mechanical damage.	
	CK2125		Inductance change: Within ±20% Q change: Within ±30%	
	CKS2125		No mechanical damage.	
			Inductance change: Within ±20%	
	CKP1608			
Specified Value	CKP2012			
	CKP2016		No mechanical damage.	
	CKP2520		Inductance change: Within ±30%	
	NM2012			
	NM2520			
	LK1005		No mechanical damage.	
			Inductance change: Within ±10% Q change: Within ±30%	
			No mechanical damage.	
	LK1608		Inductance change: $0.047 \sim 12.0 \mu$ H: Within $\pm 10\%$ $15.0 \sim 33.0 \mu$ H: Within $\pm 15\%$	
			Q change: Within ±30%	
	LK2125		No mechanical damage.	
	LUZOADO		Inductance change: Within ±20% Q change: Within ±30%	
	HK0402			
	HK0603		_	
	HK1005			
	HK1608			
	HK2125		No mechanical damage.	
	HKQ0402 HKQ0603W		Inductance change: Within ±10% Q change: Within ±20%	
	HKQ0603S			
	HKQ0603U			
	AQ105			
	BK, BKH, BKF	P Series, MCF Series:		
	Temperature	: 125±3°C(BK, BKH Series		
		: 85±3°C(BKP, MCF Serie	es)	
		ent :Rated current		
	Duration	:500+24/-0 hrs		
	Recovery		der the standard condition after the removal from test chamber.	
T . M		(See Note 1)		
Test Methods and	114 014 0140	OVD NIM LIK LIKO AO O		
Remarks		CKP、NM、HK、HKQ、AQ Ser : 85 ± 2 °C(LK、CK、CKS、C		
	Temperature	: 85±2°C(HK1608, 2125)	INF. NW Series)	
			operating temperature range $-55 \sim +85^{\circ}\text{C}$)	
			operating temperature range—53% +65 C/ 402, HK0603, HK1005, HKQ0603S, HKQ0603U, HKQ0603W, AQ105	
	Applied curre	operating temperature range – 55 ~ + 125°C) Applied current : Rated current		
	Duration	:500±12 hrs		
	Recovery		der the standard condition after the test.(See Note 1)	
Note on standard		ard condition" referred to here		

5 to 35°C of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of $20\pm2^{\circ}C$ of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure. Unless otherwise specified, all the tests are conducted under the "standard condition."

(Note 1) Measurement shall be made after 48 ± 2 hrs of recovery under the standard condition.

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Precautions on the use of Multilayer chip inductors Multilayer chip inductors for high frequency, Multilayer chip bead inductors Multilayer common mode choke coils (MC series F type)

■PRECAUTIONS

1. Circuit Design

♦ Verification of operating environment, electrical rating and performance

 A malfunction in medical equipment, spacecraft, nuclear reactors, etc. may cause serious harm to human life or have severe social ramifications.

Precautions

As such, any inductors to be used in such equipment may require higher safety and/or reliability considerations and should be clearly differentiated from components used in general purpose applications.

- ◆Operating Current(Verification of Rated current)
 - 1. The operating current for inductors must always be lower than their rated values.
 - 2. Do not apply current in excess of the rated value because the inductance may be reduced due to the magnetic saturation effect.

2. PCB Design

Precautions

◆Pattern configurations(Design of Land-patterns)

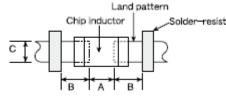
1. When inductors are mounted on a PCB, the size of land patterns and the amount of solder used (size of fillet) can directly affect inductor performance.

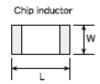
Therefore, the following items must be carefully considered in the design of solder land patterns:

- (1) The amount of solder applied can affect the ability of chips to withstand mechanical stresses which may lead to breaking or cracking. Therefore, when designing land-patterns it is necessary to consider the appropriate size and configuration of the solder pads which in turn determines the amount of solder necessary to form the fillets.
- (2) When more than one part is jointly soldered onto the same land or pad, the pad must be designed so that each component's soldering point is separated by solder-resist.
- (3) The larger size of land patterns and amount of solder, the smaller Q value after mounting on PCB. It makes higher the Q value to design land patterns smaller than terminal electrode of chips.
- ◆Pattern configurations (Inductor layout on panelized[breakaway] PC boards)
 - 1. After inductors have been mounted on the boards, chips can be subjected to mechanical stresses in subsequent manufacturing processes (PCB cutting, board inspection, mounting of additional parts, assembly into the chassis, wave soldering the reflow soldered boards etc.) For this reason, planning pattern configurations and the position of SMD inductors should be carefully performed to minimize stress

◆Pattern configurations(Design of Land-patterns)

- The following diagrams and tables show some examples of recommended patterns to prevent excessive solder amounts (larger fillets which extend above the component end terminations). Examples of improper pattern designs are also shown.
 - (1) Recommended land dimensions for a typical chip inductor land patterns for PCBs





Recommended land dimensions for wave-soldering (Unit:mm)

Туре		1608	2125	3216
C:	┙	1.6	2.0	3.2
Size	W	0.8	1.25	1.6
Α		0.8~10	1.0~1.4	1.8~2.5
В		0.5~0.8	0.8~1.5	0.8~1.7
С		0.6~0.8	0.9~1.2	1.2~1.6

Technical considerations

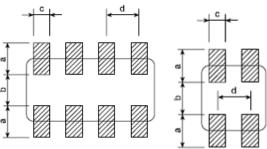
Recommended land dimensions for reflow-soldering (Unit:mm)

Ту	ре	0402	0603	1005	105	1608	2012
Size	L	0.4	0.6	1.0	1.0	1.6	2.0
Size	W	0.2	0.3	0.5	0.6	0.8	1.25
-	4	0.15~0.25	0.20~0.30	0.45~0.55	0.50~0.55	0.8~1.0	0.8~1.2
Е	3	0.10~0.20	0.20~0.30	0.40~0.50	0.30~0.40	0.6~0.8	0.8~1.2
(2	0.15~0.30	0.25~0.40	0.45~0.55	0.60~0.70	0.6~0.8	0.9~1.6

Ту	ре	2125	2016	2520	3216
C:	L	2.0	2.0	2.5	3.2
Size	W	1.25	1.6	2.0	1.6
A	١	0.8~1.2	0.8~1.2	1.0~1.4	1.8~2.5
В		0.8~1.2	0.8~1.2	0.6~1.0	0.6~1.5
С		0.9~1.6	1.2~2.0	1.8~2.2	1.2~2.0

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Excess solder can affect the ability of chips to withstand mechanical stresses. Therefore, please take proper precautions when designing land-patterns.



Recommended land dimension for Reflow-soldering					
Туре		3216	2010	1210	0806
C:==	L	3.2	2.0	1.25	0.85
Size	W	1.6	1.0	1.0	0.65
а		0.7~0.9	0.5~0.6	0.45~0.55	0.25~0.35
b		0.8~1.0	0.5~0.6	0.7~0.8	0.25~0.35

0.2~0.3

0.5

0.25~0.35

0.55

0.25~0.35

0.5

d (Unit:mm)

С

0.4~0.5

8.0

((2) Examples of good and bad solder application

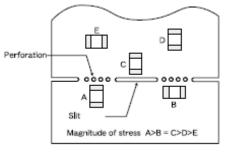
(2	?)Examples of good and bad solder application				
	Item	Not recommended	Recommended		
	Mixed mounting of SMD and leaded components	Lead wire of component	Sokier-resist		
	Component placement close to the chassis	Chassis Solder(for grounding)	Solder-resist		
	Hand-soldering of leaded components near mounted components	Lead wire of component- Soldering iron	Solder-resist-		
	Horizontal component placement		Solder-resist		

- ◆Pattern configurations (Inductor layout on panelized[breakaway] PC boards)
 - 1-1. The following are examples of good and bad inductor layout; SMD inductors should be located to minimize any possible mechanical stresses from board warp or deflection.

Item	Nt recommended	Recommended	
Deflection of the board			Position the component at a right angle to the direction of the mechanical stresses that are anticipated.

1-2. To layout the inductors for the breakaway PC board, it should be noted that the amount of mechanical stresses given will vary depending on inductor layout.

An example below should be counted for better design.



1-3. When breaking PC boards along their perforations, the amount of mechanical stress on the inductors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, slit, V-grooving, and perforation. Thus, any ideal SMD inductor layout must also consider the PCB splitting procedure.

3. Considerations for automatic placement

- ◆Adjustment of mounting machine
 - 1. Excessive impact load should not be imposed on the inductors when mounting onto the PC boards.
 - 2. The maintenance and inspection of the mounter should be conducted periodically.

Precautions

◆ Selection of Adhesives

1. Mounting inductors with adhesives in preliminary assembly, before the soldering stage, may lead to degraded inductor characteristics unless the following factors are appropriately checked; the size of land patterns, type of adhesive, amount applied, hardening temperature and hardening period. Therefore, it is imperative to consult the manufacturer of the adhesives on proper usage and amounts of adhesive to use.

◆Adjustment of mounting machine

- 1. If the lower limit of the pick-up nozzle is low, too much force may be imposed on the inductors, causing damage. To avoid this, the following points should be considered before lowering the pick-up nozzle:
 - (1) The lower limit of the pick-up nozzle should be adjusted to the surface level of the PC board after correcting for deflection of the board.
 - (2) The pick-up pressure should be adjusted between 1 and 3N static loads.
 - (3) To reduce the amount of deflection of the board caused by impact of the pick-up nozzle, supporting pins or back-up pins should be used under the PC board. The following diagrams show some typical examples of good pick-up nozzle placement:

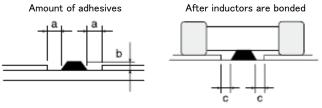
Item	Improper method	Proper method
Single-sided mounting	chipping or cracking	supporting pins or back-up pins
Double-sided mounting	onbooking or cracking	supporting pins

Technical considerations

- 2. As the alignment pin wears out, adjustment of the nozzle height can cause chipping or cracking of the inductors because of mechanical impact on the inductors. To avoid this, the monitoring of the width between the alignment pin in the stopped position, and maintenance, inspection and replacement of the pin should be conducted periodically.
- ◆Selection of Adhesives
- 1. Some adhesives may cause reduced insulation resistance. The difference between the shrinkage percentage of the adhesive and that of the inductors may result in stresses on the inductors and lead to cracking. Moreover, too little or too much adhesive applied to the board may adversely affect component placement, so the following precautions should be noted in the application of adhesives.
 - (1) Required adhesive characteristics
 - a. The adhesive should be strong enough to hold parts on the board during the mounting & solder process.
 - b. The adhesive should have sufficient strength at high temperatures.
 - c. The adhesive should have good coating and thickness consistency.
 - d. The adhesive should be used during its prescribed shelf life.
 - e. The adhesive should harden rapidly.
 - f. The adhesive must not be contaminated.
 - g. The adhesive should have excellent insulation characteristics.
 - h. The adhesive should not be toxic and have no emission of toxic gasses.
 - (2) When using adhesives to mount inductors on a PCB, inappropriate amounts of adhesive on the board may adversely affect component placement. Too little adhesive may cause the inductors to fall off the board during the solder process. Too much adhesive may cause defective soldering due excessive flow of adhesive on to the land or solder pad.

[Recommended conditions]

[
Figure	0805 case sizes as examples	
а	0.3mm min	
b	100∼120 μ m	
С	Area with no adhesive	



4. Soldering

◆Selection of Flux

- 1. Since flux may have a significant effect on the performance of inductors, it is necessary to verify the following conditions prior to use:
 - (1) Flux used should be with less than or equal to 0.1 wt% (Chlorine conversion method) of halogenated content. Flux having a strong acidity content should not be applied.
 - (2) When soldering inductors on the board, the amount of flux applied should be controlled at the optimum level.
 - (3) When using water-soluble flux, special care should be taken to properly clean the boards.

♦Soldering

1. Temperature, time, amount of solder, etc. are specified in accordance with the following recommended conditions, and please contact us about peak temperature when you use lead-free paste.

Technical considerations

Precautions

◆Selection of Flux

1-1. When too much halogenated substance (Chlorine, etc.) content is used to activate the flux, or highly acidic flux is used, an excessive

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amount of residue after soldering may lead to corrosion of the terminal electrodes or degradation of insulation resistance on the surface of the Inductor.

- 1-2. Flux is used to increase solderability in flow soldering, but if too much is applied, a large amount of flux gas may be emitted and may detrimentally affect solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.
- 1-3. Since the residue of water-soluble flux is easily dissolved by water content in the air, the residue on the surface of Inductor in high humidity conditions may cause a degradation of insulation resistance and therefore affect the reliability of the components. The cleaning methods and the capability of the machines used should also be considered carefully when selecting water-soluble flux.

Soldering

1-1. Preheating when soldering

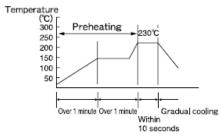
Heating: Chip inductor components should be preheated to within 100 to 130°C of the soldering. Cooling: The temperature difference between the components and cleaning process should not be greater than 100°C.

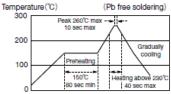
Chip inductors are susceptible to thermal shock when exposed to rapid or concentrated heating or rapid cooling. Therefore, the soldering process must be conducted with a great care so as to prevent malfunction of the components due to excessive thermal

Recommended conditions for soldering

[Reflow soldering]

Temperature profile

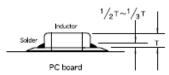




*Ceramic chip components should be preheated to within 100 to 130°C of the soldering.

*Assured to be reflow soldering for 2 times.

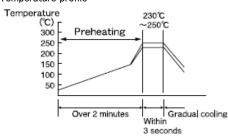
1. The ideal condition is to have solder mass (fillet) controlled to 1/2 to 1/3 of the thickness of the inductor, as shown below:

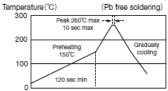


2. Because excessive dwell times can detrimentally affect solderability, soldering duration should be kept as close to recommended times as possible.

[Wave soldering]

Temperature profile





*Ceramic chip components should be preheated to within 100 to 130°C of the soldering

*Assured to be wave soldering for 1 time.

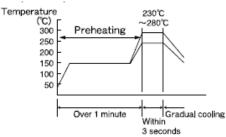
*Except for reflow soldering type

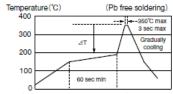
Caution

- 1. Make sure the inductors are preheated sufficiently.
- 2. The temperature difference between the inductor and melted solder should not be greater than 100 to 130°C.
- 3. Cooling after soldering should be as gradual as possible.
- 4. Wave soldering must not be applied to the inductors designated as for reflow soldering only.

[Hand soldering]

Temperature profile





(**\angle TT190°C(3216Type max), \angle T\leq 130°C(3225 Type ming)

XIt is recommended to use 20W soldering iron and the tip is 1 ϕ or less.

*The soldering iron should not directly touch the components

*Assured to be soldering iron for 1 time

Note: The above profiles are the maximum allowable soldering condition, therefore these profiles are not always recommended.

Caution

- 1. Use a 20W soldering iron with a maximum tip diameter of 1.0 mm.
- 2. The soldering iron should not directly touch the inductor.

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5. Cleaning Cleaning conditions 1. When cleaning the PC board after the Inductors are all mounted, select the appropriate cleaning solution according to the type of flux Precautions used and purpose of the cleaning (e.g. to remove soldering flux or other materials from the production process.) 2. Cleaning conditions should be determined after verifying, through a test run, that the cleaning process does not affect the inductor's characteristics. Cleaning conditions 1. The use of inappropriate solutions can cause foreign substances such as flux residue to adhere to the inductor, resulting in a degradation of the inductor's electrical properties (especially insulation resistance). 2. Inappropriate cleaning conditions (insufficient or excessive cleaning) may detrimentally affect the performance of the inductors. (1) Excessive cleaning Technical a. In the case of ultrasonic cleaning, too much power output can cause excessive vibration of the PC board which may lead to the considerations cracking of the inductor or the soldered portion, or decrease the terminal electrodes' strength. Thus the following conditions should be carefully checked; Ultrasonic output Below 20W/Q Below 40kHz Ultrasonic frequency Ultrasonic washing period 5 min. or less

6. Post cleaning processes

◆Application of resin coatings, moldings, etc. to the PCB and components.

Precautions

- With some type of resins a decomposition gas or chemical reaction vapor may remain inside the resin during the hardening period or while left under normal storage conditions resulting in the deterioration of the inductor's performance.
- 2. When a resin's hardening temperature is higher than the inductor's operating temperature, the stresses generated by the excess heat may lead to inductor damage or destruction.
- 3. Stress caused by a resin's temperature generated expansion and contraction may damage inductors.

The use of such resins, molding materials etc. is not recommended.

7. Handling

- ◆Breakaway PC boards (splitting along perforations)
 - 1. When splitting the PC board after mounting inductors and other components, care is required so as not to give any stresses of deflection or twisting to the board.
 - 2. Board separation should not be done manually, but by using the appropriate devices.
- ◆General handling precautions
 - 1. Always wear static control bands to protect against ESD.
 - 2. Keep the inductors away from all magnets and magnetic objects.
- Precautions

 3. Use non-magnetic tweezers when handling inductors.
 - 4. Any devices used with the inductors (soldering irons, measuring instruments) should be properly grounded.
 - 5. Keep bare hands and metal products (i.e., metal desk) away from chip electrodes or conductive areas that lead to chip electrodes.
 - 6. Keep inductors away from items that generate magnetic fields such as speakers or coils.
 - ◆Mechanical considerations
 - 1. Be careful not to subject the inductors to excessive mechanical shocks.
 - (1) If inductors are dropped on the floor or a hard surface they should not be used.
 - (2) When handling the mounted boards, be careful that the mounted components do not come in contact with or bump against other boards or components.

8. Storage conditions

◆Storage

1. To maintain the solderability of terminal electrodes and to keep the packaging material in good condition, care must be taken to control temperature and humidity in the storage area. Humidity should especially be kept as low as possible.

Precautions

Ambient temperature Below 40°C

Humidity Below 70% RH

Recommended conditions

The ambient temperature must be kept below 30° C. Even under ideal storage conditions inductor electrode solderability decreases as time passes, so inductors should be used within 6 months from the time of delivery.

*The packaging material should be kept where no chlorine or sulfur exists in the air.

Technical considerations

♦Storage

1. If the parts are stocked in a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. For this reason, components should be used within 6 months from the time of delivery. If exceeding the above period, please check solderability before using the inductors.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).